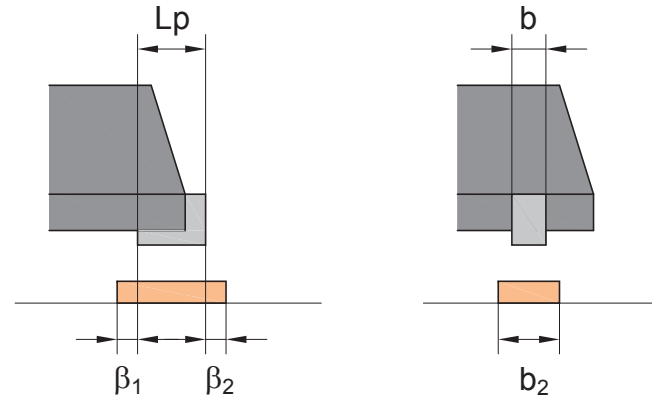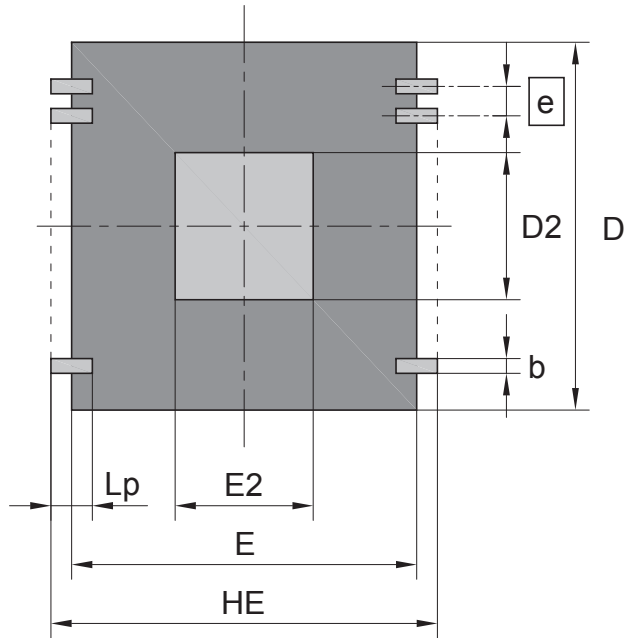# SON, HSON
Mount Pad Dimensions

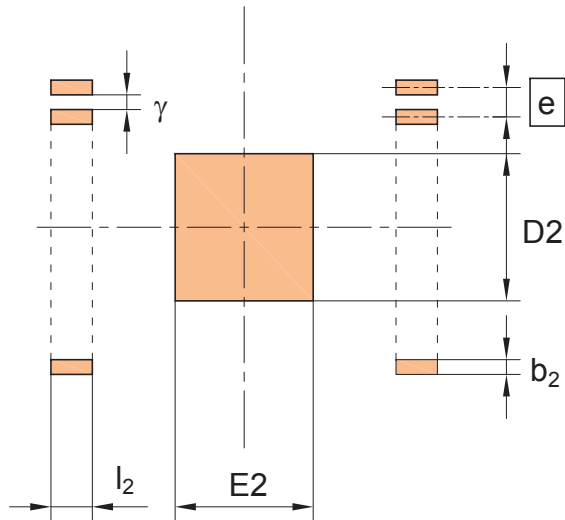

$$l_2 = L + \beta_1 + \beta_2$$

$$b \leq b_2 \leq e - \gamma$$

Lp = Leadlength
b = Leadwidth

l_2 and b_2 can get by following formula and value e and b from package drawing figure and below parameter table.

• Dimension parameter (Unit: mm)

	e: 0.65	0.50
β_1	0 to 0.30	0 to 0.30
β_2	0 to 0.30	0 to 0.30
γ	0.10 to 0.30	0.10 to 0.30

(Reference value)

Note
In case to use thermal pad, the size of thermal pad should be the same as the diepad.